CY29774

2.5V or 3.3V, 125-MHz, 14 Output Zero Delay Buffer

Features

- **Output frequency range: 8.3 MHz to 125 MHz**
- **Input frequency range: 4.2 MHz to 62.5 MHz**
- **2.5V or 3.3V operation**
- **Split 2.5V/3.3V outputs**
- **14 Clock outputs: Drive up to 28 clock lines**
- **1 Feedback clock output**
- **2 LVCMOS reference clock inputs**
- **150 ps max output-output skew**
- **PLL bypass mode**
- **Spread Aware™**
- **Output enable/disable**
- **Pin compatible with MPC9774**
- **Industrial temperature range: –40°C to +85°C**
- **52-Pin 1.0-mm TQFP package**

Description

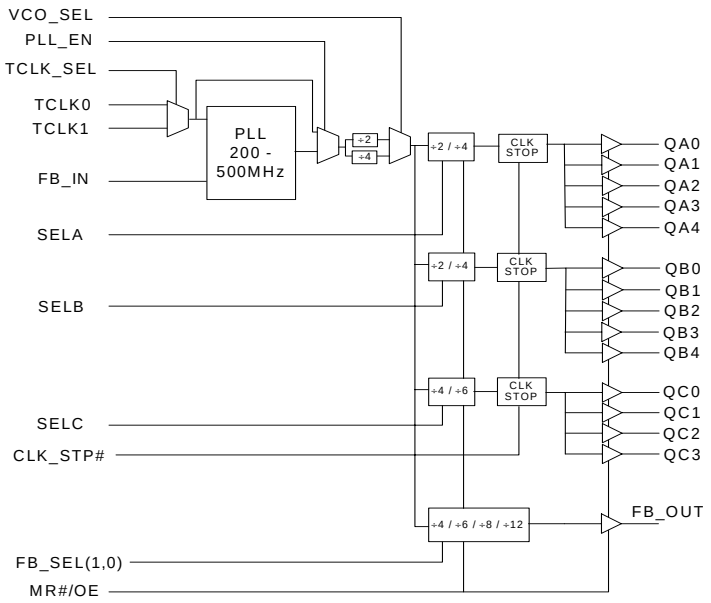
The CY29774 is a low-voltage high-performance 125-MHz PLL-based zero delay buffer designed for high-speed clock distribution applications.

The CY29774 features two reference clock inputs and provides 14 outputs partitioned in 3 banks of 5, 5, and 4 outputs. Bank A and Bank B divide the VCO output by 4 or 8 while Bank C divides by 8 or 12 per SEL(A:C) settings, see *Functional Table*. These dividers allow output to input ratios of 6:1, 4:1, 3:1, 2:1, 3:2, 4:3, 1:1, and 2:3. Each LVCMOS compatible output can drive 50Ω series or parallel terminated transmission lines. For series terminated transmission lines, each output can drive one or two traces giving the device an effective fanout of 1:28.

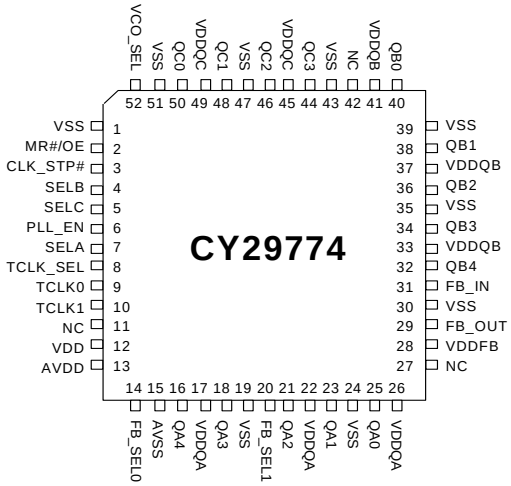
The PLL is ensured stable given that the VCO is configured to run between 200 MHz to 500 MHz. This allows a wide range of output frequencies from 8.3 MHz to 125 MHz. For normal operation, the external feedback input, FB_IN, is connected to the feedback output, FB_OUT. The internal VCO is running at multiples of the input reference clock set by the feedback divider, see *Frequency Table.*

When PLL_EN is LOW, PLL is bypassed and the reference clock directly feeds the output dividers. This mode is fully static and the minimum input clock frequency specification does not apply.

Block Diagram



Pin Configuration



Pin Description[1]

Pin	Name	I/O	Type	Description
9	TCLK0	I, PD	LVCMOS	LVCMOS/LVTTL reference clock input
10	TCLK1	I, PU	LVCMOS	LVCMOS/LVTTL reference clock input
16, 18, 21, 23, 25	QA(4:0)	O	LVCMOS	Clock output bank A
32, 34, 36, 38, 40	QB(4:0)	O	LVCMOS	Clock output bank B
44, 46, 48, 50	QC(3:0)	O	LVCMOS	Clock output bank C
29	FB_OUT	O	LVCMOS	**Feedback clock output**. Connect to FB_IN for normal operation.
31	FB_IN	I, PU	LVCMOS	**Feedback clock input**. Connect to FB_OUT for normal operation. This input should be at the same voltage rail as input reference clock. See *Table 1*.
2	MR#/OE	I, PU	LVCMOS	**Output enable/disable input**. See *Table 2*.
3	CLK_STP#	I, PU	LVCMOS	**Clock stop enable/disable input**. See *Table 2*.
6	PLL_EN	I, PU	LVCMOS	**PLL enable/disable input**. See *Table 2*.
8	TCLK_SEL	I, PD	LVCMOS	**Reference select input**. See *Table 2*.
52	VCO_SEL	I, PD	LVCMOS	**VCO divider select input**. See *Table 2*.
7, 4, 5	SEL(A:C)	I, PD	LVCMOS	**Frequency select input, Bank (A:C)**. See *Table 3*.
20, 14	FB_SEL(1,0)	I, PD	LVCMOS	**Feedback dividers select input**. See *Table 4*.
17, 22, 26	VDDQA	Supply	VDD	2.5V or 3.3V Power supply for bank A output clocks[2,3]
33, 37, 41	VDDQB	Supply	VDD	2.5V or 3.3V Power supply for bank B output clocks[2,3]
45, 49	VDDQC	Supply	VDD	2.5V or 3.3V Power supply for bank C output clocks[2,3]
28	VDDFB	Supply	VDD	2.5V or 3.3V Power supply for feedback output clock[2,3]
13	AVDD	Supply	VDD	2.5V or 3.3V Power supply for PLL[2,3]
12	VDD	Supply	VDD	2.5V or 3.3V Power supply for core and inputs[2,3]
15	AVSS	Supply	Ground	Analog Ground
1, 19, 24, 30, 35, 39, 43, 47, 51	VSS	Supply	Ground	Common Ground
11, 27, 42	NC			No Connection

Notes:

1. PU = Internal pull up, PD = Internal pull down
2. A 0.1-µF bypass capacitor should be placed as close as possible to each positive power pin (<0.2”). If these bypass capacitors are not close to the pins their high frequency filtering characteristics will be cancelled by the lead inductance of the traces.
3. AVDD and VDD pins must be connected to a power supply level that is at least equal or higher than that of VDDQA, VDDQB, VDDQC, and VDDFB power supply pins.

Table 1. Frequency Table

Feedback Output Divider	VCO	Input Frequency Range (AVDD = 3.3V)	Input Frequency Range (AVDD = 2.5V)
÷8	Input Clock * 8	25 MHz to 62.5 MHz	25 MHz to 50 MHz
÷12	Input Clock * 12	16.6 MHz to 41.6 MHz	16.6 MHz to 33.3 MHz
÷16	Input Clock * 16	12.5 MHz to 31.25 MHz	12.5 MHz to 25 MHz
÷24	Input Clock * 24	8.3 MHz to 20.8 MHz	8.3 MHz to 16.6 MHz
÷32	Input Clock * 32	6.25 MHz to 15.625 MHz	6.25 MHz to 12.5 MHz
÷48	Input Clock * 48	4.2 MHz to 10.4 MHz	4.2 MHz to 8.3 MHz

Table 2. Function Table (configuration controls)

Control	Default	0	1
TCLK_SEL	0	TCLK0	TCLK1
VCO_SEL	0	VCO÷2 (high input frequency range)	VCO÷4 (low input frequency range)
PLL_EN	1	Bypass mode, PLL disabled. The input clock connects to the output dividers	PLL enabled. The VCO output connects to the output dividers
MR#/OE	1	Outputs disabled (three-state) and reset of the device. During reset/output disable the PLL feedback loop is open and the VCO running at its minimum frequency. The device is reset by the internal power-on reset (POR) circuitry during power-up.	Outputs enabled
CLK_STP#	1	QA, QB, and QC outputs disabled in LOW state. FB_OUT is not affected by CLK_STP#.	Outputs enabled

Table 3. Function Table (Bank A, B and C)

VCO_SEL	SELA	QA(4:0)	SELB	QB(4:0)	SELC	QC(3:0)
0	0	÷4	0	÷4	0	÷8
0	1	÷8	1	÷8	1	÷12
1	0	÷8	0	÷8	0	÷16
1	1	÷16	1	÷16	1	÷24

Table 4. Function Table (FB_OUT)

VCO_SEL	FB_SEL1	FB_SEL0	FB_OUT
0	0	0	÷8
0	0	1	÷16
0	1	0	÷12
0	1	1	÷24
1	0	0	÷16
1	0	1	÷32
1	1	0	÷24
1	1	1	÷48

Absolute Maximum Conditions

Parameter	Description	Condition	Min.	Max.	Unit
V_{DD}	DC Supply Voltage		–0.3	5.5	V
V_{DD}	DC Operating Voltage	Functional	2.375	3.465	V
V_{IN}	DC Input Voltage	Relative to V_{SS}	–0.3	V_{DD} + 0.3	V
V_{OUT}	DC Output Voltage	Relative to V_{SS}	–0.3	V_{DD} + 0.3	V
V_{TT}	Output termination Voltage		–	$V_{DD} \div 2$	V
LU	Latch Up Immunity	Functional	200	–	mA
R_{PS}	Power Supply Ripple	Ripple Frequency < 100 kHz	–	150	mVp-p
T_S	Temperature, Storage	Non Functional	–65	+150	°C
T_A	Temperature, Operating Ambient	Functional	–40	+85	°C
T_J	Temperature, Junction	Functional	–	150	°C
$Ø_{JC}$	Dissipation, Junction to Case	Functional	–	23	°C/W
$Ø_{JA}$	Dissipation, Junction to Ambient	Functional	–	55	°C/W
ESD_H	ESD Protection (Human Body Model)		2000	–	Volts
FIT	Failure in Time	Manufacturing test	10		ppm

DC Electrical Specifications (V_{DD}= 2.5V ± 5%, T_A = –40°C to +85°C)

Parameter	Description	Condition	Min.	Typ.	Max.	Unit
V_{IL}	Input Voltage, Low	LVCMOS	–	–	0.7	V
V_{IH}	Input Voltage, High	LVCMOS	1.7	–	V_{DD}+0.3	V
V_{OL}	Output Voltage, Low[4]	I_{OL} = 15 mA	–	–	0.6	V
V_{OH}	Output Voltage, High[4]	I_{OH} = –15 mA	1.8	–	–	V
I_{IL}	Input Current, Low[5]	$V_{IL} = V_{SS}$	–	–	–100	µA
I_{IH}	Input Current, High[5]	$V_{IL} = V_{DD}$	–	–	–	µA
I_{DDA}	PLL Supply Current	A_{VDD} only	–	5	10	mA
I_{DDQ}	Quiescent Supply Current	All V_{DD} pins except A_{VDD}	–	–	1	mA
I_{DD}	Dynamic Supply Current	Outputs loaded @ 100 MHz	–	135	–	mA
C_{IN}	Input Pin Capacitance		–	4	–	pF
Z_{OUT}	Output Impedance		14	18	22	Ω

DC Electrical Specifications (V_{DD}= 3.3V ± 5%, T_A = –40°C to +85°C)

Parameter	Description	Condition	Min.	Typ.	Max.	Unit
V_{IL}	Input Voltage, Low	LVCMOS	–	–	0.8	V
V_{IH}	Input Voltage, High	LVCMOS	2.0	–	V_{DD}+0.3	V
V_{OL}	Output Voltage, Low[4]	I_{OL} = 24 mA	–	–	0.55	V
		I_{OL} = 12 mA	–	–	0.30	
V_{OH}	Output Voltage, High[4]	I_{OH} = –24 mA	2.4	–	–	V
I_{IL}	Input Current, Low[5]	$V_{IL} = V_{SS}$	–	–	–100	µA
I_{IH}	Input Current, High[5]	$V_{IL} = V_{DD}$	–	–	100	µA

Notes:

4. Driving one 50Ω parallel terminated transmission line to a termination voltage of V_{TT}. Alternatively, each output drives up to two 50Ω series terminated transmission lines.
5. Inputs have pull-up or pull-down resistors that affect the input current.

DC Electrical Specifications (V_{DD}= 3.3V ± 5%, T_A = –40°C to +85°C) (continued)

Parameter	Description	Condition	Min.	Typ.	Max.	Unit
I_{DDA}	PLL Supply Current	A_{VDD} only	–	5	10	mA
I_{DDQ}	Quiescent Supply Current	All V_{DD} pins except A_{VDD}	–	–	1	mA
I_{DD}	Dynamic Supply Current	Outputs loaded @ 100 MHz	–	225	–	mA
C_{IN}	Input Pin Capacitance		–	4	–	pF
Z_{OUT}	Output Impedance		12	15	18	Ω

AC Electrical Specifications[6] (V_{DD}= 2.5V ± 5%, T_A = –40°C to +85°C)

Parameter	Description	Condition	Min.	Typ.	Max.	Unit
f_{VCO}	VCO Frequency		200	–	400	MHz
f_{in}	Input Frequency	÷8 Feedback	25	–	50	MHz
		÷12 Feedback	16.6	–	33.3	
		÷16 Feedback	12.5	–	25	
		÷24 Feedback	8.3	–	16.6	
		÷32 Feedback	6.3	–	12.5	
		÷48 Feedback	4.2	–	8.3	
		Bypass mode (PLL_EN = 0)	0	–	200	
f_{refDC}	Input Duty Cycle		25	–	75	%
t_r , t_f	TCLK Input Rise/FallTime	0.7V to 1.7V	–	–	1.0	ns
f_{MAX}	Maximum Output Frequency	÷4 Output	50	–	100	MHz
		÷8 Output	25	–	50	
		÷12 Output	16.6	–	33.3	
		÷16 Output	12.5	–	25	
		÷24 Output	8.3	–	16.6	
DC	Output Duty Cycle		45	–	55	%
t_r , t_f	Output Rise/Fall times	0.7V to 1.8V	0.1	–	1.0	ns
$t_{(\phi)}$	Propagation Delay (static phase offset)	TCLK to FB_IN, does not include jitter	–100	–	100	ps
$t_{sk(O)}$	Output-to-Output Skew	Skew within Bank	–	–	150	ps
tsk(B)	Bank-to-Bank Skew	Banks at same frequency	–	–	150	ps
		Banks at different frequency	–	–	225	
$t_{PLZ, HZ}$	Output Disable Time		–	–	10	ns
$t_{PZL, ZH}$	Output Enable Time		–	–	10	ns
BW	PLL Closed Loop Bandwidth (–3 dB)		–	0.5 - 1.0	–	MHz
$t_{JIT(CC)}$	Cycle-to-Cycle Jitter	Same frequency	–	–	150	ps
		Multiple frequencies	–	–	300	
$t_{JIT(PER)}$	Period Jitter		–	–	100	ps
$t_{JIT(\phi)}$	I/O Phase Jitter		–	–	150	ps
t_{LOCK}	Maximum PLL Lock Time		–	–	1	ms

Note:
6. AC characteristics apply for parallel output termination of 50Ω to V_{TT}. Parameters are guaranteed by characterization and are not 100% tested.

AC Electrical Specifications[6] (V_{DD}= 3.3V ± 5%, T_A = –40°C to +85°C)

Parameter	Description	Condition	Min.	Typ.	Max.	Unit
f_{VCO}	VCO Frequency		200	–	500	MHz
f_{in}	Input Frequency	÷8 Feedback	25	–	62.5	MHz
		÷12 Feedback	16.6	–	41.6	
		÷16 Feedback	12.5	–	31.25	
		÷24 Feedback	8.3	–	20.8	
		÷32 Feedback	6.25	–	15.625	
		÷48 Feedback	4.2	–	10.4	
		Bypass mode (PLL_EN = 0)	0	–	200	
f_{refDC}	Input Duty Cycle		25	–	75	%
t_r , t_f	TCLK Input Rise/FallTime	0.8V to 2.0V		–	1.0	ns
f_{MAX}	Maximum Output Frequency	÷4 Output	50	–	125	MHz
		÷8 Output	25	–	62.5	
		÷12 Output	16.6	–	41.6	
		÷16 Output	12.5	–	31.25	
		÷24 Output	8.3	–	20.8	
DC	Output Duty Cycle		45	–	55	%
t_r , t_f	Output Rise/Fall times	0.8V to 2.4V	0.1	–	1.0	ns
$t_{(\phi)}$	Propagation Delay (static phase offset)	TCLK to FB_IN, same V_{DD}, does not include jitter	–100	–	100	ps
$t_{sk(O)}$	Output-to-Output Skew	Skew within Bank	–	–	150	ps
$t_{sk(B)}$	Bank-to-Bank Skew	Banks at same voltage, same frequency	–	–	150	ps
		Banks at same voltage, different frequency	–	–	225	
		Banks at different voltage	–	–	250	
$t_{PLZ, HZ}$	Output Disable Time		–	–	10	ns
$t_{PZL, ZH}$	Output Enable Time		–	–	10	ns
BW	PLL Closed Loop Bandwidth (–3dB)		–	0.5 - 1.0	–	MHz
$t_{JIT(CC)}$	Cycle-to-Cycle Jitter	Same frequency	–	–	150	ps
		Multiple frequencies	–	–	300	
$t_{JIT(PER)}$	Period Jitter		–	–	100	ps
$t_{JIT(\phi)}$	I/O Phase Jitter	I/O at same V_{DD}	–	–	150	ps
t_{LOCK}	Maximum PLL Lock Time		–	–	1	ms

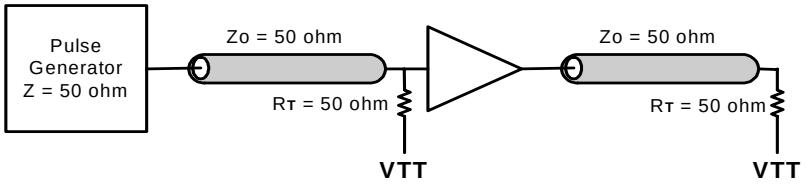


Figure 1. AC Test Reference for V_{DD} = 3.3V / 2.5V

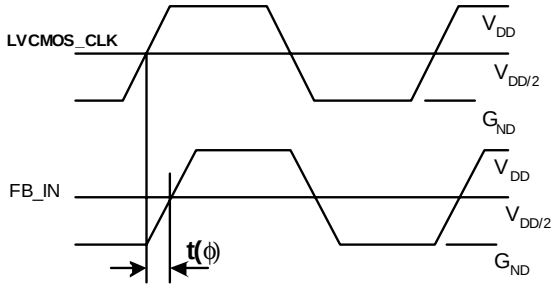


Figure 2. Propagation Delay t(ϕ), Static Phase Offset

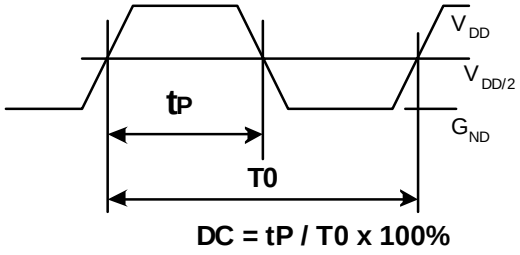


Figure 3. Output Duty Cycle (DC)

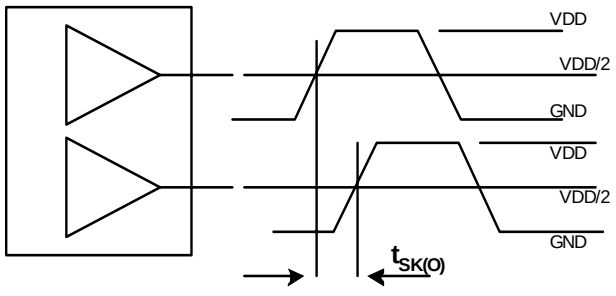


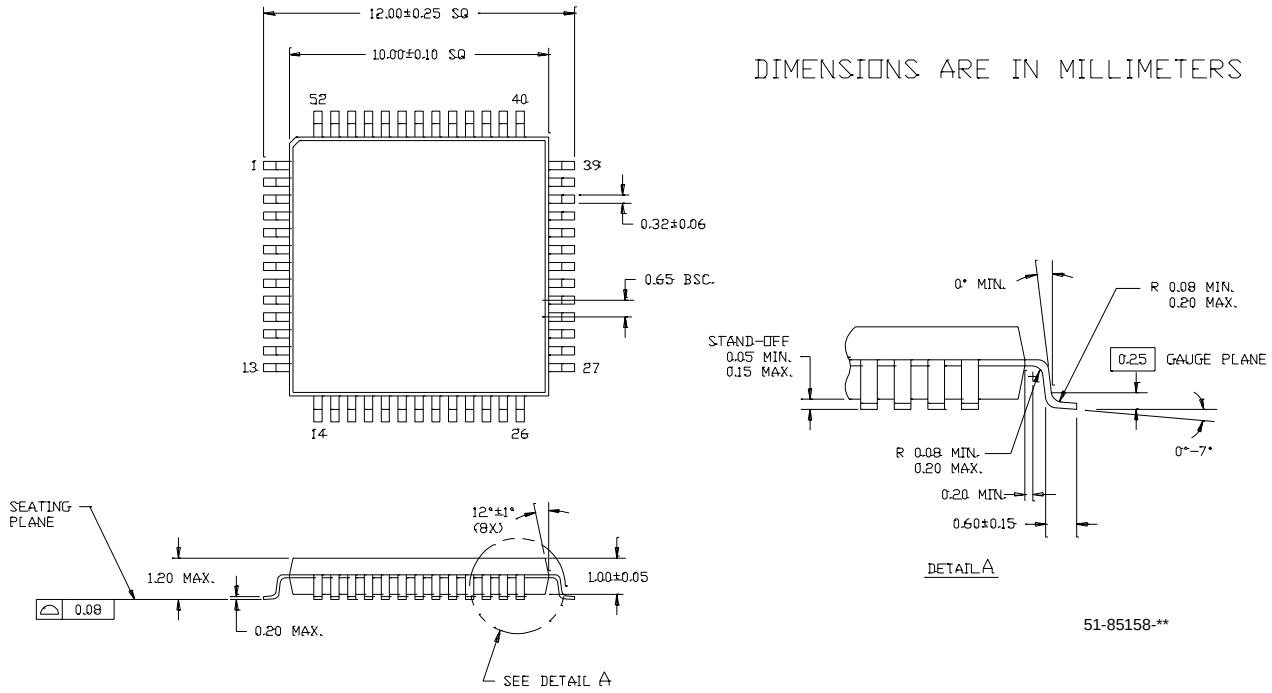
Figure 4. Output-to-Output Skew, $t_{sk(O)}$

Ordering Information

Part Number	Package Type	Product Flow
CY29774AI	52-pin TQFP	Industrial, –40°C to +85°C
CY29774AIT	52-pin TQFP -Tape and Reel	Industrial, –40°C to 85°C

Package Drawing and Dimension

52-Lead Thin Plastic Quad Flat Pack (10 x 10 x 1.0 mm) A52B



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Document History Page

Document Title:CY29774 2.5V or 3.3V, 125-MHz, 14 Output Zero Delay Buffer Document #: 38-07479				
Rev.	**ECN No.**	**Issue Date**	**Orig. of Change**	**Description of Change**
**	125954	05/01/03	RGL	New Data Sheet